tML® - Module-/Blind Plate for Rack Mount Enclosure 19''/1U extendable for 8x Modules

\*\*tML® - tde Modular Link

tML® is a patented, modular cabling system consisting of the three key components module, trunk cable and rack mount enclosure. The system components are 100 percent manufactured, pre-assembled and tested in Germany. They enable plug-and-play installation on site – especially in data centres, but also in industrial environments – within the shortest possible time. Heart of the system are the rear MPO/MTP® and Telco connectors, which can be used to connect at least six or twelve ports at a time. Depending on the module configuration, transfer rates of up to 200G are currently possible with SR4. The fibre optic and TP modules can be used together in a module carrier with a very high port density. The tde offers its tML® cabling system as a proven tML® standard system and in the highly innovative variants tML® Xtended, tML® 24 System and now tML® 32 System for extreme scalability and very easy migration to higher transmission rates such as 40G, 100G, 200G and 400G.

\*\*tML® - Rack Mount Enclosures 1U + Accessories

The tML® - Module Blind Plate is intended for the cover of unused slots in the tML® - Rack Mount Enclosure 1U extendable (for 8 x Modules).

\*\*TECHNISCHE\_DATEN

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| Material | Stainless steel |
| Dimensions | 10.7 x 2 cm (WxH) |
| Mounting method | toolless through snap in |
|  | QS-Managementsystem ISO 9001, ISO 14001 and TL 9000 |